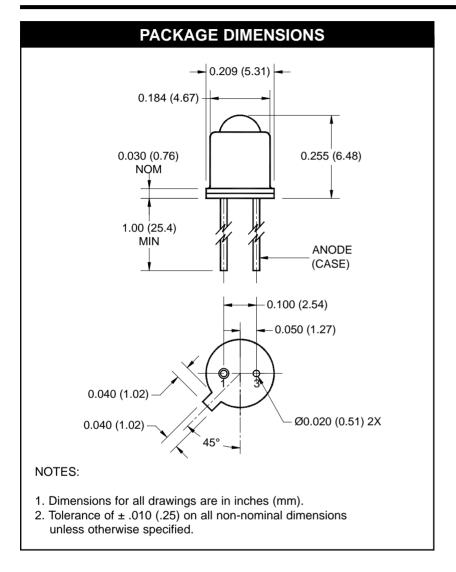
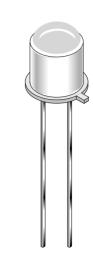
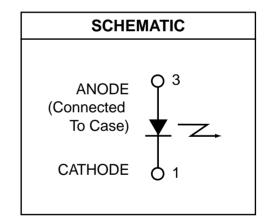
LED55B L

LED55C

LED56







DESCRIPTION

The LED55B/LED55C/LED56 are 940 nm LEDs in a narrow angle, TO-46 package.

FEATURES

- · Good optical to mechanical alignment
- Mechanically and wavelength matched to the TO-18 series phototransistor
- · Hermetically sealed package
- High irradiance level



LED55B LED55C LED56

ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise specified)								
Parameter	Symbol	Symbol Rating						
Operating Temperature	T _{OPR}	-65 to +125	°C					
Storage Temperature	T _{STG}	-65 to +150	°C					
Soldering Temperature (Iron)(3,4,5 and 6)	T _{SOL-I}	240 for 5 sec	°C					
Soldering Temperature (Flow)(3,4 and 6)	T _{SOL-F}	260 for 10 sec	°C					
Continuous Forward Current	l _F	100	mA					
Forward Current (pw, 1µs; 200Hz)	l _F	10	A					
Reverse Voltage	V _R	3	V					
Power Dissipation (T _A = 25°C) ⁽¹⁾	P _D	170	mW					
Power Dissipation (T _C = 25°C) ⁽²⁾	P _D	1.3	W					

NOTE:

- 1. Derate power dissipation linearly 1.70 mW/°C above 25°C ambient.
- 2. Derate power dissipation linearly 13.0 mW/°C above 25°C case.
- 3. RMA flux is recommended.
- 4. Methanol or isopropyl alcohols are recommended as cleaning agents.
- 5. Soldering iron tip 1/16" (1.6mm) minimum from housing.
- 6. As long as leads are not under any stress or spring tension
- 7. Total power output, P_0 , is the total power radiated by the device into a solid angle of 2 π steradians.

ELECTRICAL / OPTICAL CHARACTERISTICS (TA =25°C) (All measurements made under pulse conditions)								
PARAMETER	TEST CONDITIONS	SYMBOL	MIN	TYP	MAX	UNITS		
Peak Emission Wavelength	I _F = 100 mA	λ _P	_	940	_	nm		
Emission Angle at 1/2 Power	I _F = 100 mA	θ	_	±8	_	Deg.		
Forward Voltage	I _F = 100 mA	V _F	_	_	1.7	V		
Reverse Leakage Current	V _R = 3 V	I _R	_	_	10	μA		
Total Power LED55B(7)	I _F = 100 mA	Po	3.5	_	_	mW		
Total Power LED55C(7)	I _F = 100 mA	Po	5.4	_	_	mW		
Total Power LED56(7)	I _F = 100 mA	Po	1.5	_	_	mW		
Rise Time 0-90% of output		t _r	_	1.0	_	μs		
Fall Time 100-10% of output		t _f	_	1.0	_	μs		

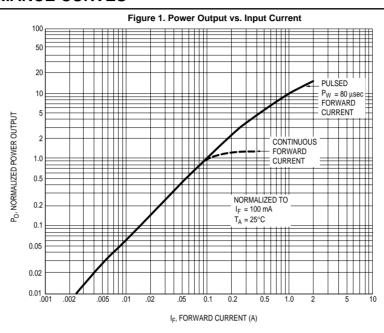


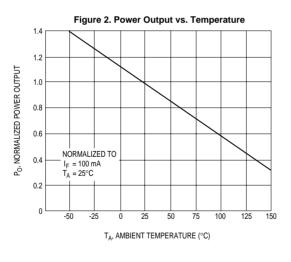
LED55B

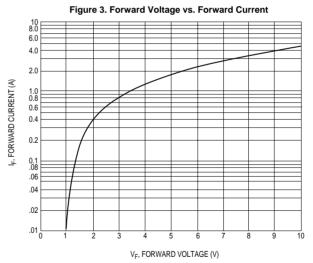
LED55C

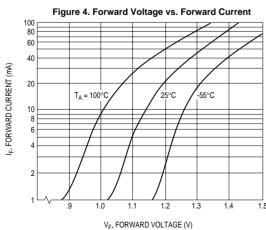
LED56

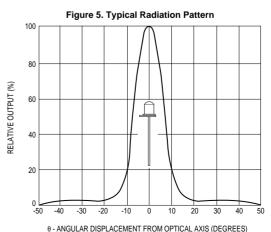
TYPICAL PERFORMANCE CURVES













LED55B

LED55C

LED56

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- A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.